

08-02-2001

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To the Honorable Commissioner of Patents and Trademarks, Please receive the attached original documents or copy thereof.

1. Name of conveying party(ies):

Tatsuya USAMI

7/23/01

2. Name and address of receiving party(ies):

Name: NEC Corporation

Address: 7-1, Shiba 5-chome

11036 U.S. PRO
09/910994
07/23/01

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

City: Minato-ku

State/Prov.: Tokyo

Country: JAPAN

ZIP:

Execution Date: July 17, 2001

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: July 17, 2001

Patent Application No.

Filing date

B. Patent No.(s)

09/910994

07/26/2001 TGL:AMU1 00000014 09/910994
02 FC:581

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Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Norman P. Soloway

Registration No. 24,315

Address: Hayes, Soloway, Hennessey, Grossman & Hage PC

175 Canal Street

City: Manchester

State/Prov.: NH

Country: USA

ZIP: 03101

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

☒ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☐ Authorized to be charged to deposit account

8. Deposit account number:

08-1391

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Norman P. Soloway

July 23, 2001

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and

3

PATENT

REEL: 012018 FRAME: 0279

ASSIGNMENT

FOREIGN - IN THE UNITED STATES OF AMERICA

I/we Tatsuya USAMI

of Tokyo, Japan

having invented certain inventions and improvements in _____

SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

and having executed an application for Letters Patent of the United States of America describing the same and based thereon on _____; (and I/we hereby authorize our attorneys, authorized to prosecute said application, to here insert the filing date and serial number of said application, when known, Serial No. _____, filed _____), for good and valuable consideration, the receipt of which is hereby

acknowledged from **NEC CORPORATION**, a Japanese corporation having its principal place of business at 7-1, Shiba 5-chome, Minato-Ku, Tokyo, Japan, (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my/our entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United states of America;

And for the same consideration I/we do agree that I/we will upon request execute any instrument which the Assignee may desire to carry this Assignment into effect and perfect the title transferred hereby or prosecute the above-mentioned application;

And I/we do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent on the said application to the Assignee;

And I/we do hereby jointly and severally covenant for ourselves and for our legal representatives that I/we have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions or any of them or any part thereof has not been otherwise encumbered by us, and that I/we have not executed and will not execute any instrument in conflict herewith.

IN WITNESS WHEREOF, I/we hereunto set our hands and seals on the day and year hereinafter noted.

Sole or first

Inventor's signature Tatsuya Usami Date 17/07/2001

Full name (typed or printed) Tatsuya USAMI

Witness: Hiroshi Ueki Witness: [Signature]

Date: 17/07/2001 Date: 17/07/2001

Second Inventor's

signature _____ Date _____

Full name (typed or printed) _____

Witness: _____ Witness: _____

Date: _____ Date: _____

Third Inventor's

signature _____ Date _____

Full name (typed or printed) _____

Witness: _____ Witness: _____

Date: _____ Date: _____

Fourth Inventor's

signature _____ Date _____

Full name (typed or printed) _____

Witness: _____ Witness: _____

Date: _____ Date: _____